



Certificate of Registration

QUALITY MANAGEMENT SYSTEM - TL 9000-H R6.0/R5.5

This is to certify that:

Semiconductor Manufacturing International (Shanghai) Corporation No. 18, Zhangjiang Road Pudong New Area Shanghai 201203 China 中芯国际集成电路制造(上海)有限公司 91310115710939629R 中国 上海 浦东新区 张江路18号 邮编: 201203

Holds Certificate No: FM 91658

and operates a Quality Management System which complies with the requirements of TL 9000-H R6.0/R5.5 for the following scope:

Please see scope page.

For and on behalf of BSI:

Chris Cheung, Head of Compliance & Risk - Asia Pacific

Original Registration Date: 2005-05-10 Latest Revision Date: 2018-03-07 Effective Date: 2017-04-23 Expiry Date: 2020-04-22

Page: 1 of 4



...making excellence a habit."

This certificate was issued electronically and remains the property of BSI and is bound by the conditions of contract.

An electronic certificate can be authenticated <u>online</u>.

Printed copies can be validated at www.bsi-global.com/ClientDirectory or telephone +86 10 8507 3000.

Further clarifications regarding the scope of this certificate and the applicability of TL 9000-H R6.0/R5.5 requirements may be obtained by consulting the organization.

This certificate is valid only if provided original copies are in complete set.

Certificate No: **FM 91658**

Registered Scope:

and operates a Quality Management System which complies with the requirements of TL9000-H R6.0/ R5.5 for the following scope:

The manufacture of gigantic scale integration (GSI). The provision of Wafer Bumping, Wafer Level Chip Scale Packaging(WLCSP), Chip Probing (CP) Test and Die Processing Service (DPS).

Product Category: 8.1.2 Integrated circuits. 并运行符合TL9000-H R6.0/R5.5要求的质量管理体系,认证范围如下:

巨大规模集成电路的制造。 晶圆凸块,晶圆片级芯片规模封装,针测及晶粒加工服务。

产品类别: 8.1.2 集成电路。

Original Registration Date: 2005-05-10 Latest Revision Date: 2018-03-07 Effective Date: 2017-04-23 Expiry Date: 2020-04-22

Page: 2 of 4

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Certificate No: **FM 91658**

Location

Semiconductor Manufacturing International (Shanghai) Corporation No. 18, Zhangjiang Road Pudong New Area Shanghai 201203 China 中芯国际集成电路制造(上海)有限公司 91310115710939629R 中国 上海 浦东新区 张江路18号 邮编: 201203

Semiconductor Manufacturing International (Tianjin) Corporation

Xiging Economic Development Area

中芯国际集成电路制造(天津)有限公司

No. 19 Xinghua Road

91120111717869977N

西青经济开发区 兴华道19号 邮编: 300385

Tianiin

300385 China

中国 天津 **Registered Activities**

The manufacture of gigantic scale integration (GSI). The provision of Wafer Bumping, Wafer Level Chip Scale Packaging(WLCSP), Chip Probing (CP) Test and Die Processing Service (DPS).

Product Category: 8.1.2 Integrated circuits. 巨大规模集成电路的制造。 晶圆凸块,晶圆片级芯片规模封装,针测及晶粒加工服务。

产品类别: 8.1.2 集成电路。

The manufacture of gigantic scale integration (GSI).

Product Category: 8.1.2 Integrated circuits. 巨大规模集成电路的制造。

产品类别: 8.1.2 集成电路。

Original Registration Date: 2005-05-10 Latest Revision Date: 2018-03-07

Effective Date: 2017-04-23 Expiry Date: 2020-04-22

Page: 3 of 4

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Certificate No: **FM 91658**

Location

Semiconductor Manufacturing International (Beijing) Corporation No. 18, Wenchang Road Economic-Technological Development Area Beijing 100176 China 中芯国际集成电路制造(北京)有限公司 911103027404017237 中国 北京 北京市经济技术开发区 文昌大道18号

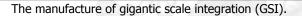
邮编: 100176 Semiconductor Manufacturing International (Shenzhen) Corporation No. 18, Gaoxin Road Export Processing Zone PingShan New Area Shenzhen Guangdong 518118 China 中芯国际集成电路制造(深圳)有限公司 914403006729728144 中国 广东省 深圳 坪山新区出口加工区高芯路18号 邮编: 518118

Registered Activities

The manufacture of gigantic scale integration (GSI).

Product Category: 8.1.2 Integrated circuits. 巨大规模集成电路的制造。

产品类别: 8.1.2 集成电路。



Product Category: 8.1.2 Integrated circuits. 巨大规模集成电路的制造。

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